HIGH-DENSITY PRESS-FIT OPEN-PIN-FIELD

Mates with: SEAM, SEAM-RA, SEAMP

Notes:
Applications with varying board thickness refer to Samtec compliant pin termination specifications. Some sizes, styles and options are non-standard, non-returnable.

SPECIFICATIONS
For complete specifications and recommended PCB layouts see www.samtec.com?SEAFP-RA

Insulator Material:
Natural LCP

Contact Material:
Copper Alloy

Operating Temp Range:
-55 °C to +125 °C

Current Rating:
1.3 A per pin
(10 adjacent pins powered)

Plating:
Au or Sn over
50 µ" (1.27 µm) Ni

Working Voltage:
195 VAC / 275 VDC

RoHS Compliant:
Yes

TOOLING
• Compliant pin fixture
CAT: SEAFP-XX-XX-RA
For more information, visit www.samtec.com/tooling

For complete specifications and recommended PCB layouts see www.samtec.com?SEAFP-RA

Due to technical progress, all designs, specifications and components are subject to change without notice.

Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.

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